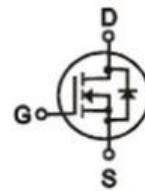



• General Description

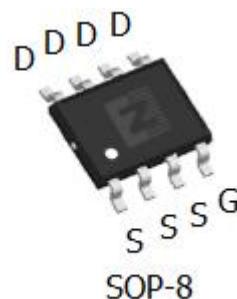
It combines trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

• Product Summary

 $V_{DS} = 40V$
 $R_{DS(ON)} = 5.5m\Omega$
 $I_D = 15A$
• Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

• Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver


• Ordering Information:

| | |
|---------------------------|-----------|
| Part NO. | ZM042N04S |
| Marking | ZM042N04 |
| Packing Information | REEL TAPE |
| Basic ordering unit (pcs) | 4000 |

• Absolute Maximum Ratings ($T_C = 25^\circ C$)

| Parameter | Symbol | Rating | Unit |
|---|-----------------------|------------|------------|
| Drain-Source Voltage | V_{DS} | 40 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current | $I_D@T_C=25^\circ C$ | 15 | A |
| | $I_D@T_C=75^\circ C$ | 11.4 | A |
| | $I_D@T_C=100^\circ C$ | 9.5 | A |
| Pulsed Drain Current ^① | I_{DM} | 45 | A |
| Total Power Dissipation($T_C=25^\circ C$) | $P_D@T_C=25^\circ C$ | 70 | W |
| Total Power Dissipation($T_A=25^\circ C$) | $P_D@T_A=25^\circ C$ | 2.5 | W |
| Operating Junction Temperature | T_J | -55 to 150 | $^\circ C$ |
| Storage Temperature | T_{STG} | -55 to 150 | $^\circ C$ |
| Single Pulse Avalanche Energy | E_{AS} | 125 | mJ |

**•Thermal resistance**

| Parameter | Symbol | Min. | Typ. | Max. | Unit |
|---|-------------------|------|------|------|------|
| Thermal resistance, junction - case | R _{thJC} | - | - | 2.1 | °C/W |
| Thermal resistance, junction - ambient | R _{thJA} | - | - | 65 | °C/W |
| Soldering temperature, wave soldering for 10s | T _{sold} | - | - | 265 | °C |

•Electronic Characteristics

| Parameter | Symbol | Condition | Min. | Typ | Max. | Unit |
|-----------------------------------|---------------------|--|------|-----|------|------|
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =250uA | 40 | | | V |
| Gate Threshold Voltage | V _{GS(TH)} | V _{GS} =V _{DS} , I _D =250uA | 1.2 | | 2.5 | V |
| Drain-Source Leakage Current | I _{DSS} | V _{DS} =40V, V _{GS} =0V | | | 1.0 | uA |
| Gate- Source Leakage Current | I _{GSS} | V _{GS} =±20V ,V _{DS} =0V | | | ±100 | nA |
| Static Drain-source On Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =24A | | 5.5 | 7.0 | mΩ |
| | | V _{GS} =4.5V, I _D =12A | | 7.6 | 10.0 | mΩ |
| Forward Trans conductance | g _{FS} | V _{DS} =25V, I _D =10A | | 12 | | s |
| Source-drain voltage | V _{SD} | I _S =24A | | | 1.28 | V |

•Electronic Characteristics

| Parameter | Symbol | Condition | Min. | Typ | Max. | Unit |
|------------------------------|------------------|----------------------------------|------|------|------|------|
| Input capacitance | C _{iss} | f = 1MHz V _{DS} =25V | - | 2300 | - | pF |
| Output capacitance | C _{oss} | | - | 300 | - | |
| Reverse transfer capacitance | C _{rss} | | - | 160 | - | |

•Gate Charge characteristics(T_a = 25°C)

| Parameter | Symbol | Condition | Min. | Typ | Max. | Unit |
|----------------------|-----------------|--|------|-----|------|------|
| Total gate charge | Q _g | V _{DD} =25V I _D = 8A V _{GS} = 10V | - | 20 | - | nC |
| Gate - Source charge | Q _{gs} | | - | 9 | - | |
| Gate - Drain charge | Q _{gd} | | - | 11 | - | |

Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;



Fig.1 Power Dissipation

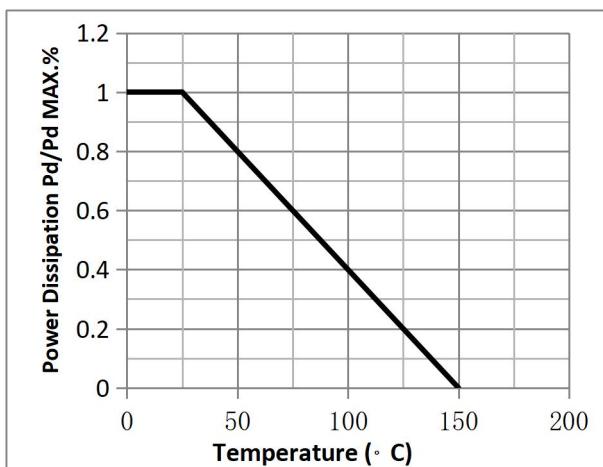


Fig.2 Typical output Characteristics

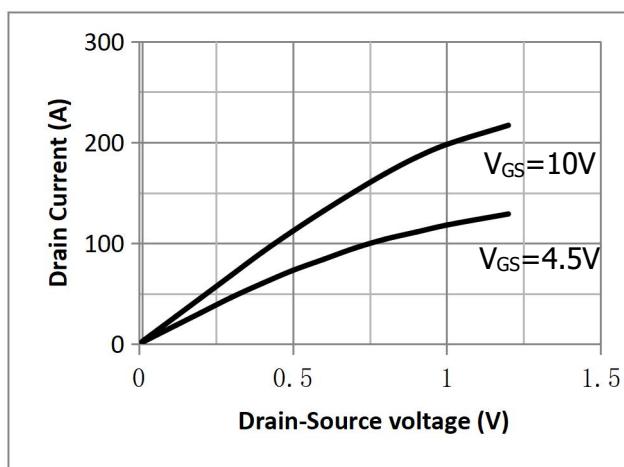


Fig.3 Threshold Voltage V.S Junction Temperature

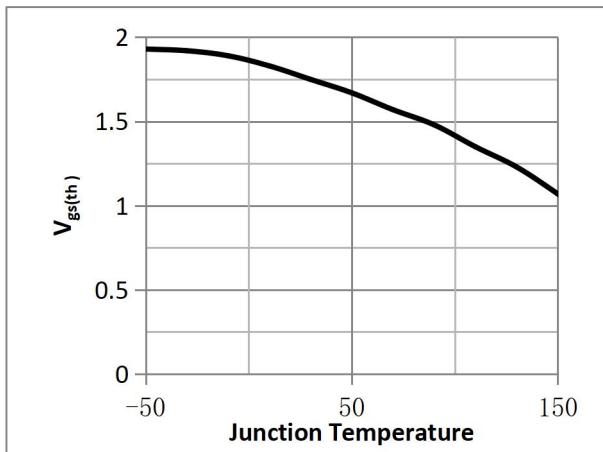


Fig.4 Resistance V.S Drain Current

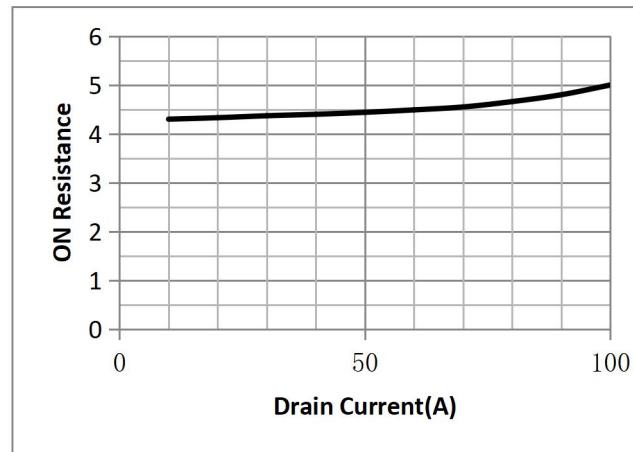


Fig.5 On-Resistance VS Gate Source Voltage

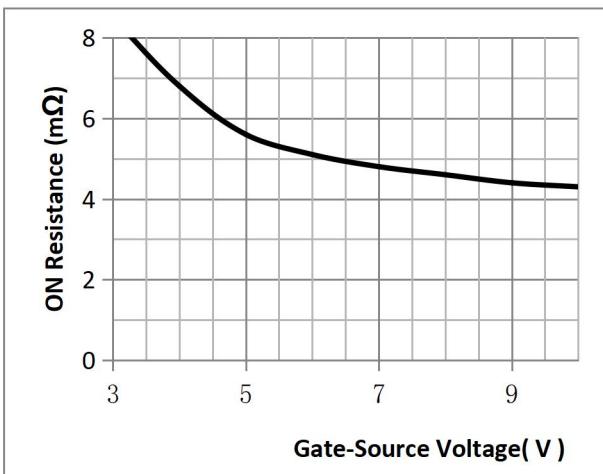


Fig.6 On-Resistance V.S Junction Temperature

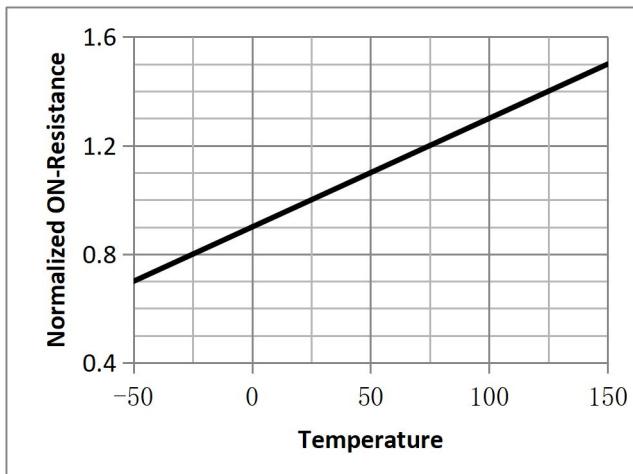




Fig.7 Switching Time Measurement Circuit

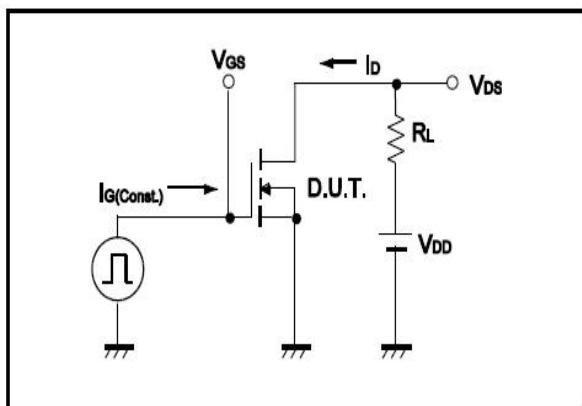


Fig.8 Gate Charge Waveform

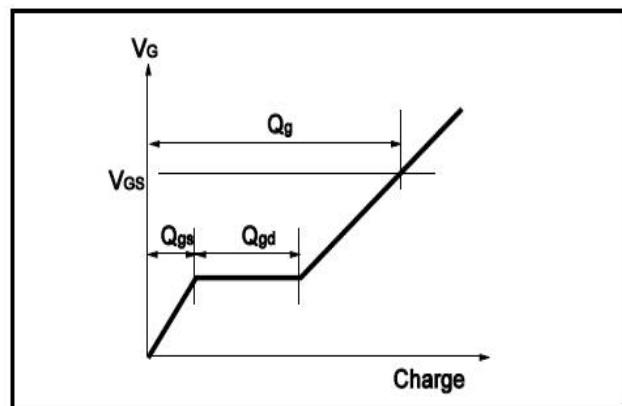


Fig.9 Switching Time Measurement Circuit

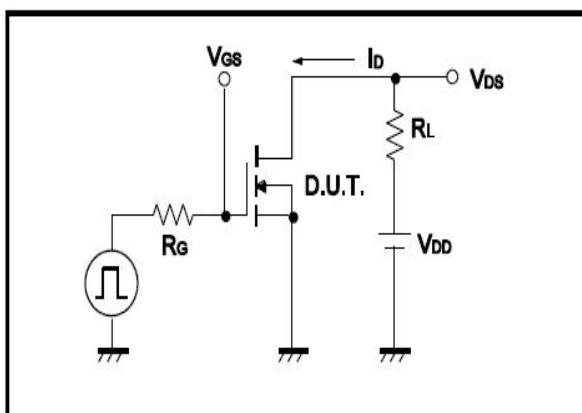


Fig.10 Gate Charge Waveform

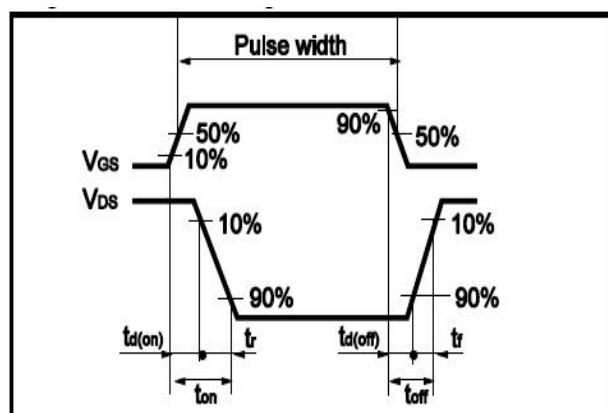


Fig.11 Avalanche Measurement Circuit

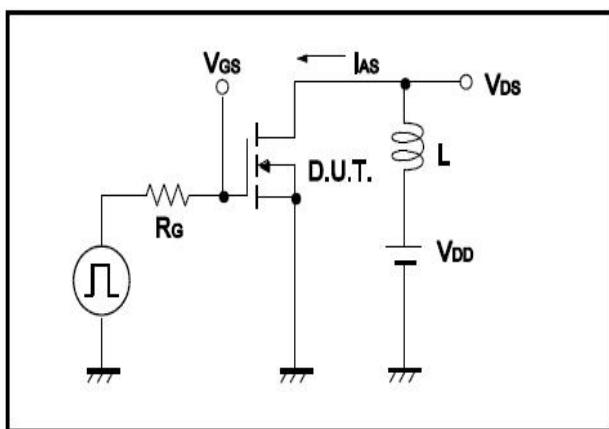
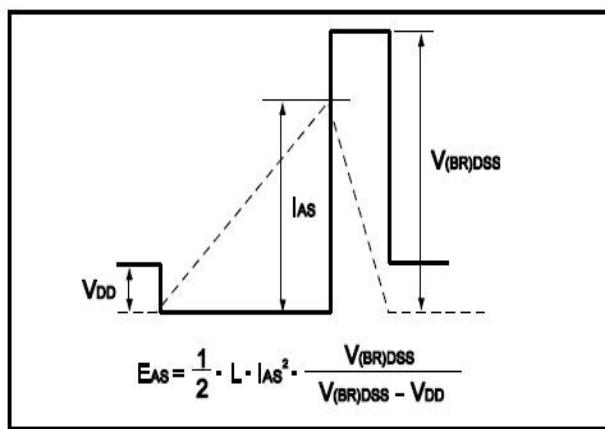


Fig.12 Avalanche Waveform



**•Dimensions(SOP8)**

Unit: mm

| SYMBOL | min | TYP | max | SYMBOL | min | | max |
|--------|------|------|------|--------|------|------|------|
| A | 4.80 | | 5.00 | C | 1.30 | | 1.50 |
| A1 | 0.37 | | 0.47 | C1 | 0.55 | | 0.75 |
| A2 | | 1.27 | | C2 | 0.55 | | 0.65 |
| A3 | | 0.41 | | C3 | 0.05 | | 0.20 |
| B | 5.80 | | 6.20 | C4 | 0.19 | 0.20 | 0.23 |
| B1 | 3.80 | | 4.00 | D | | 1.05 | |
| B2 | | 5.00 | | D1 | 0.40 | | 0.62 |

